

University Pavilion Application

AEC Next Technology Expo + Conference and SPAR 3D Expo & Conference are both a tradeshow and conferences featuring the latest 3D technology and AEC products on the market, including hardware, software, and tools that help the end-user visualize data. Much of the innovation in this industry is taking place at leading research and technical universities around the world. Universities specializing in 3D sensing, processing and visualization are invited to participate in the University Pavilion. If accepted, the University Pavilion allows you to attend the conference sessions, display research in the exhibit hall, and present in the University 3D Tech Launch session. Faculty, staff, and students are invited to host a display.

UNIVERSITY INFORMATION

University Name:

University Mailing Address:

City:

State:

Country:

Postal Code:

Telephone:

Email:

Department Website:

PRIMARY CONTACT INFORMATION

Name:

Title:

Telephone:

Email:

PRESENTATION DESCRIPTION

Please describe the research you will be presenting in 150 words or less. (Note: this description will be used on the event website.)

PRICE AND INCLUSIONS

- **2019 Price:** \$1000 USD

Included in the price:

- **Two Combo Conference Passes:** Access to all presentations for AEC Next and SPAR 3D, Keynote Sessions, Welcome Cocktail Reception (must be 21+), Product Preview Presentations, and access to the exhibition hall.

(For groups larger than two – additional conference passes available at 50% off)

- **Exhibit Hall Display Area:** 6'x30" table, (2) chairs, waste basket, university title sign, poster wall for displaying research posters, pipe and drape, carpet.
- **NEW University 3D Tech Launch:** Present your latest university research in lightening round format, each presentation will be limited to five minutes. This friendly competition will be presented in front of a panel of experts and conference attendees. Propose the problem and your solution clearly and concisely (and quickly!). Presentations will be evaluated on 1) most innovative application, 2) most forward thinking solution, and 3) most commercially feasible/direct to market. One winner will be awarded as Best Overall and receive a complimentary slot in the University Pavilion for 2019!

-Present your research to an audience of experienced 3D professionals interested in innovative applications and solutions

-Increase your exposure to an audience of potential collaborators

-Receive advice from a panel of industry-leading experts

-Gain experience giving presentations with purpose

PAYMENT INFORMATION

- Payment instruction included on invoice

AUTHORIZATION

We agree to abide by all Conditions, Rules and Regulations Governing AEC Next Technology Expo + Conference and SPAR 3D Expo & Conference included with this application. We understand that acceptance of this application by show management constitutes a legal and binding contract. The undersigned has read the Terms and Conditions as contained on the website: https://www.spar3d.com/event/wp-content/uploads/sites/2/2018/10/SPAR3D_AECNEXT_2019_TermsConditions.pdf

Signature:

Print Name:

Date:

When submitting your completed application please include a high resolution university logo.

Send to Drew Patterson at DPatterson@divcom.com